



44 FARRAND STREET  
BLOOMFIELD, NJ 07003  
(973) 748-5089

**NTE2397**  
**MOSFET**  
**N-Ch, Enhancement Mode**  
**High Speed Switch**

**Features:**

- Dynamic dv/dt Rating
- Repetitive Avalanche Rated
- Fast Switching
- Ease of Parallelizing
- Simple Drive Requirements

**Absolute Maximum Ratings:**

Continuous Drain Current ( $V_{GS} = 10V$ ),  $I_D$

$T_C = +25^\circ C$ .....	10A
$T_C = +100^\circ C$ .....	6.3A

Pulsed Drain Current (Note 1),  $I_{DM}$  .....

40A

Power Dissipation ( $T_C = +25^\circ C$ ),  $P_D$  .....

125W

Derate Linearly Above  $25^\circ C$  .....

1.0W/ $^\circ C$

Gate-to-Source Voltage,  $V_{GS}$  .....

$\pm 20V$

Single Pulse Avalanche Energy (Note 2),  $E_{AS}$  .....

520mJ

Avalanche Current (Note 1),  $I_{AR}$  .....

10A

Repetitive Avalanche Energy (Note 1),  $E_{AR}$  .....

13mJ

Peak Diode Recovery dv/dt (Note 3), dv/dt .....

4V/ns

Operating Junction Temperature Range,  $T_J$  .....

$-55^\circ$  to  $+150^\circ C$

Storage Temperature Range,  $T_{stg}$  .....

$-55^\circ$  to  $+150^\circ C$

Lead Temperature (During Soldering, 1.6mm from case for 10sec),  $T_L$  .....

$+300^\circ C$

Mounting Torque (6-32 or M3 Screw) .....

10 lbf•in (1.1N•m)

Thermal Resistance, Junction-to-Case,  $R_{thJC}$  .....

1.0°C/W

Thermal Resistance, Junction-to-Ambient,  $R_{thJA}$  .....

62°C/W

Typical Thermal Resistance, Case-to-Sink (Flat, Greased Surface),  $R_{thCS}$  .....

0.5°C/W

Note 1. Repetitive rating; pulse width limited by maximum junction temperature.

Note 2.  $V_{DD} = 50V$ , starting  $T_J = +25^\circ C$ ,  $L = 9.1\mu H$ ,  $R_G = 25\Omega$ ,  $I_{AS} = 10A$

Note 3.  $I_{SD} \leq 10A$ ,  $di/dt \leq 120A/\mu s$ ,  $V_{DD} \leq V_{(BR)DSS}$ ,  $T_J \leq +150^\circ C$

**Electrical Characteristics:** ( $T_J = +25^\circ\text{C}$  unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-to-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0V, I_D = 250\mu\text{A}$	400	—	—	V
Breakdown Voltage Temp. Coefficient	$\frac{\Delta V_{(\text{BR})\text{DSS}}}{\Delta T_J}$	Reference to $+25^\circ\text{C}$ , $I_D = 1\text{mA}$	—	0.49	—	$\text{V}/^\circ\text{C}$
Static Drain-to-Source On-Resistance	$R_{DS(\text{on})}$	$V_{GS} = 10V, I_D = 6\text{A}$ , Note 4	—	—	0.55	$\Omega$
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	2.0	—	4.0	V
Forward Transconductance	$g_{fs}$	$V_{DS} = 50V, I_D = 6\text{A}$ , Note 4	5.8	—	—	mhos
Drain-to-Source Leakage Current	$I_{DSS}$	$V_{DS} = 400V, V_{GS} = 0V$	—	—	25	$\mu\text{A}$
		$V_{DS} = 320V, V_{GS} = 0V, T_J = +125^\circ\text{C}$	—	—	250	$\mu\text{A}$
Gate-to-Source Forward Leakage	$I_{GSS}$	$V_{GS} = 20V$	—	—	100	nA
Gate-to-Source Reverse Leakage	$I_{GSS}$	$V_{GS} = -20V$	—	—	-100	nA
Total Gate Charge	$Q_g$	$I_D = 10\text{A}, V_{DS} = 320V, V_{GS} = 10V$ , Note 4	—	—	63	nC
Gate-to-Source Charge	$Q_{gs}$		—	—	9.0	nC
Gate-to-Drain ("Miller") Charge	$Q_{gd}$		—	—	32	nC
Turn-On Delay Time	$t_{d(\text{on})}$	$V_{DD} = 200V, I_D = 10\text{A}, R_G = 9.1\Omega, R_D = 20\Omega$ , Note 4	—	14	—	ns
Rise Time	$t_r$		—	27	—	ns
Turn-Off Delay Time	$t_{d(\text{off})}$		—	50	—	ns
Fall Time	$t_f$		—	24	—	ns
Internal Drain Inductance	$L_D$	Between lead, .250in. (6.0) mm from package and center of die contact	—	4.5	—	nH
Internal Source Inductance	$L_S$		—	7.5	—	nH
Input Capacitance	$C_{iss}$	$V_{GS} = 0V, V_{DS} = 25V, f = 1\text{MHz}$	—	1400	—	pF
Output Capacitance	$C_{oss}$		—	330	—	pF
Reverse Transfer Capacitance	$C_{rss}$		—	120	—	pF

**Source-Drain Ratings and Characteristics:**

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Continuous Source Current (Body Diode)	$I_S$		—	—	10	A
Pulsed Source Current (Body Diode)	$I_{SM}$	Note 1	—	—	40	A
Diode Forward Voltage	$V_{SD}$	$T_J = +25^\circ\text{C}, I_S = 10\text{A}, V_{GS} = 0V$ , Note 4	—	—	2.0	V
Reverse Recovery Time	$t_{rr}$	$T_J = +25^\circ\text{C}, I_F = 10\text{A}$ , $di/dt = 100\text{A}/\mu\text{s}$ , Note 4	—	370	790	ns
Reverse Recovery Charge	$Q_{rr}$		—	3.8	8.2	$\mu\text{C}$
Forward Turn-On Time	$t_{on}$	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S+L_D$ )				

Note 1. Repetitive rating; pulse width limited by maximum junction temperature.

Note 4. Pulse width  $\leq 300\mu\text{s}$ ; duty cycle  $\leq 2\%$ .

